HEF4794B

8-stage shift-and-store register LED driver

Rev. 11 — 14 August 2024 Product data sheet

1. General description

The HEF4794B is an 8-stage serial shift register. It has a storage latch associated with each stage for strobing data from the serial input (D) to the parallel LED driver outputs (QP0 to QP7). Data is shifted on the positive-going clock (CP) transitions. The data in each shift register stage is transferred to the storage register when the strobe input (STR) is HIGH. Data in the storage register appears at the outputs whenever the output enable input (OE) signal is HIGH.

Two serial outputs (QS1 and QS2) are available for cascading a number of HEF4794B devices. Serial data is available at QS1 on positive-going clock edges to allow high-speed operation in cascaded systems with a fast clock rise time. The same serial data is available at QS2 on the next negative going clock edge. This is used for cascading HEF4794B devices when the clock has a slow rise time.

It operates over a recommended V_{DD} power supply range of 3 V to 15 V referenced to V_{SS} (usually ground). Unused inputs must be connected to V_{DD}, V_{SS}, or another input.

2. Features and benefits

- Wide supply voltage range from 3.0 V to 15.0 V
- CMOS low power dissipation
- High noise immunity
- Fully static operation
- 5 V, 10 V, and 15 V parametric ratings
- Standardized symmetrical output characteristics
- Complies with JEDEC standard JESD 13-B
- ESD protection:
  - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
  - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

3. Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
HEF4794BT	-40 °C to +125 °C	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1

4. Functional diagram

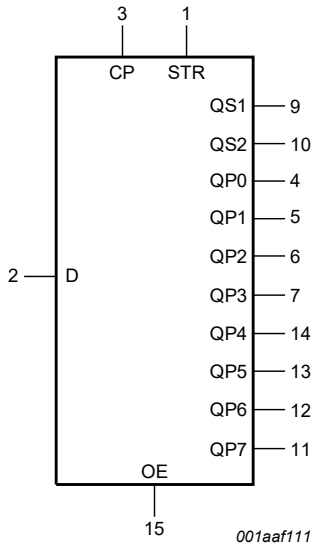


Fig. 1. Logic symbol

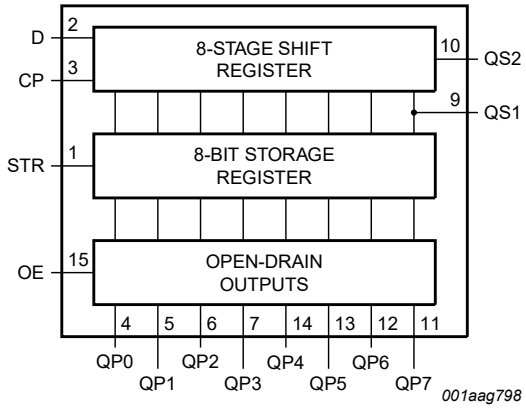


Fig. 2. Functional diagram

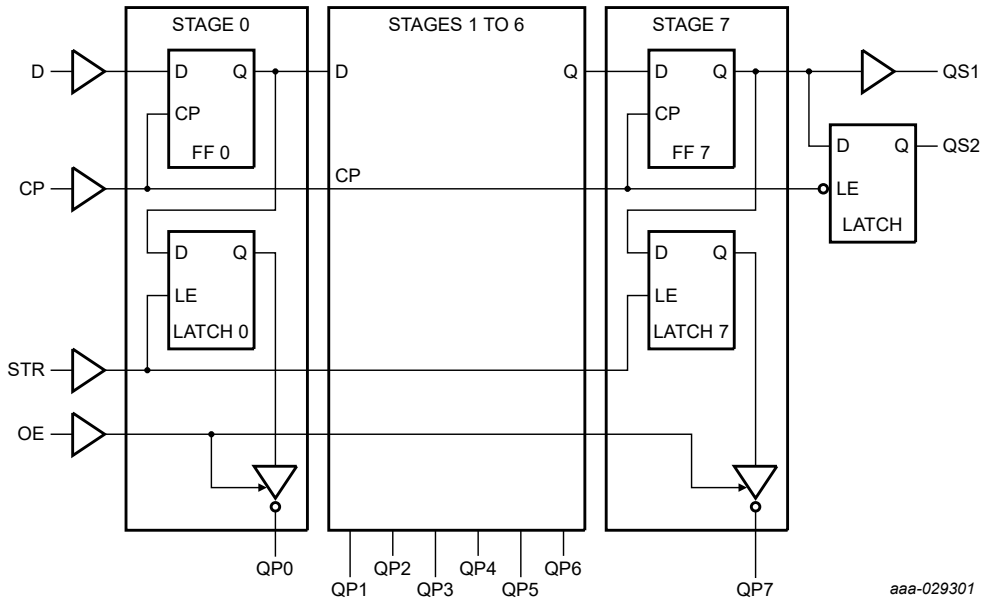
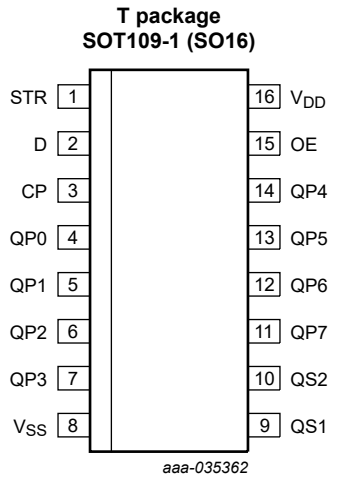


Fig. 3. Logic diagram

5. Pinning information

5.1. Pinning



5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
D	2	serial input
QP0, QP1, QP2, QP3, QP4, QP5, QP6, QP7	4, 5, 6, 7, 14, 13, 12, 11	parallel output (open-drain)
QS1, QS2	9, 10	serial output
CP	3	clock input
STR	1	strobe input
OE	15	output enable input
V_{DD}	16	supply voltage
V_{SS}	8	ground (0 V)

6. Functional description

Table 3. Function table

H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state; ↑ = LOW-to-HIGH clock transition; ↓ = HIGH-to-LOW clock transition.

Input				Parallel output		Serial output	
CP	OE	STR	D	QP0	QPn	QS1[1]	QS2[2]
↑	L	X	X	Z	Z	Q6S	no change
↓	L	X	X	Z	Z	n.c.	Q7S
↑	H	L	X	no change	no change	Q6S	no change
↑	H	H	L	Z	QPn - 1	Q6S	no change
↑	H	H	H	L	QPn - 1	Q6S	no change
↓	H	H	H	no change	no change	no change	Q7S

[1] Q6S = the data in register stage 6 before the LOW to HIGH clock transition.
[2] Q7S = the data in register stage 7 before the HIGH to LOW clock transition.

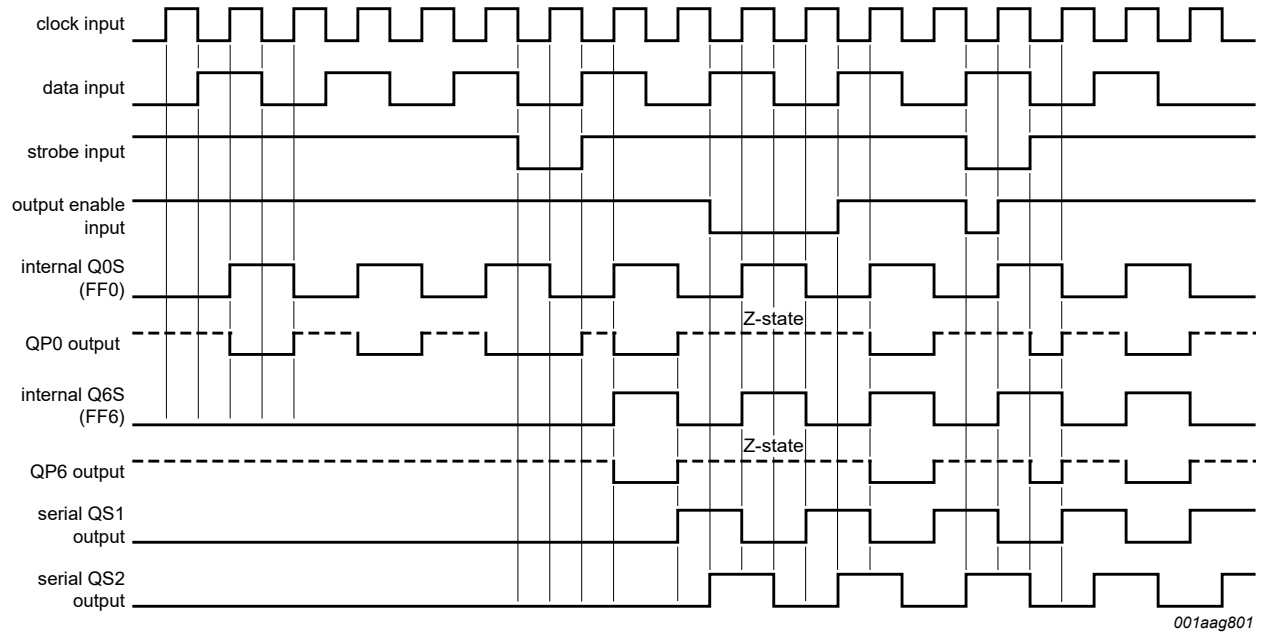


Fig. 4. Timing diagram

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DD}	supply voltage		-0.5	+18	V
I_{IK}	input clamping current	V_I < -0.5 V or V_I > V_{DD} + 0.5 V	-	±10	mA
V_I	input voltage		-0.5	V_{DD} + 0.5	V
I_{OK}	output clamping current	QSn outputs; V_O < -0.5 V or V_O > V_{DD} + 0.5 V	-	±10	mA
		QPn outputs; V_O < -0.5 V	-	40	mA
I_I	input leakage current		-	±10	mA
I_O	output current	QSn outputs	-	±10	mA
		QPn outputs	-	40	mA
T_{stg}	storage temperature		-65	+150	°C
T_{amb}	ambient temperature		-40	+125	°C
P_{tot}	total power dissipation	T_{amb} = -40 °C to +125 °C [1]	-	500	mW
P	power dissipation	per output	-	100	mW

[1] For SOT109-1 (SO16) package: P_{tot} derates linearly with 12.4 mW/K above 110 °C.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DD}	supply voltage		3	15	V
V_I	input voltage		0	V_{DD}	V
T_{amb}	ambient temperature	in free air	-40	+125	°C
Δt/ΔV	input transition rise and fall rate	V_{DD} = 5 V	-	3.75	µs/V
		V_{DD} = 10 V	-	0.5	µs/V
		V_{DD} = 15 V	-	0.08	µs/V

9. Static characteristics

Table 6. Static characteristics

V_{SS} = 0 V; V_I = V_{SS} or V_{DD}; unless otherwise specified.

Symbol	Parameter	Conditions	V_{DD}	T_{amb} = -40 °C		T_{amb} = 25 °C		T_{amb} = 85 °C		T_{amb} = 125 °C		Unit
				Min	Max	Min	Max	Min	Max	Min	Max	
V_{IH}	HIGH-level input voltage	$\|I_O\|$ < 1 µA	5 V	3.5	-	3.5	-	3.5	-	3.5	-	V
			10 V	7.0	-	7.0	-	7.0	-	7.0	-	V
			15 V	11.0	-	11.0	-	11.0	-	11.0	-	V
V_{IL}	LOW-level input voltage	$\|I_O\|$ < 1 µA	5 V	-	1.5	-	1.5	-	1.5	-	1.5	V
			10 V	-	3.0	-	3.0	-	3.0	-	3.0	V
			15 V	-	4.0	-	4.0	-	4.0	-	4.0	V
V_{OH}	HIGH-level output voltage	QSn outputs; $\|I_O\|$ < 1 µA	5 V	4.95	-	4.95	-	4.95	-	4.95	-	V
			10 V	9.95	-	9.95	-	9.95	-	9.95	-	V
			15 V	14.95	-	14.95	-	14.95	-	14.95	-	V
V_{OL}	LOW-level output voltage	QSn outputs; $\|I_O\|$ < 1 µA	5 V	-	0.05	-	0.05	-	0.05	-	0.05	V
			10 V	-	0.05	-	0.05	-	0.05	-	0.05	V
			15 V	-	0.05	-	0.05	-	0.05	-	0.05	V
		QPn outputs; $\|I_O\|$ < 20 mA	5 V	-	0.75	-	0.75	-	1.5	-	1.5	V
			10 V	-	0.75	-	0.75	-	1.5	-	1.5	V
			15 V	-	0.75	-	0.75	-	1.5	-	1.5	V
I_{OH}	HIGH-level output current	QSn outputs										
		V_O = 2.5 V	5 V	-	-1.7	-	-1.4	-	-1.1	-	-1.1	mA
		V_O = 4.6 V	5 V	-	-0.64	-	-0.5	-	-0.36	-	-0.36	mA
		V_O = 9.5 V	10 V	-	-1.6	-	-1.3	-	-0.9	-	-0.9	mA
		V_O = 13.5 V	15 V	-	-4.2	-	-3.4	-	-2.4	-	-2.4	mA
I_{OL}	LOW-level output current	QSn outputs										
		V_O = 0.4 V	5 V	0.64	-	0.5	-	0.36	-	0.36	-	mA
		V_O = 0.5 V	10 V	1.6	-	1.3	-	0.9	-	0.9	-	mA
		V_O = 1.5 V	15 V	4.2	-	3.4	-	2.4	-	2.4	-	mA
I_I	input leakage current		15 V	-	±0.1	-	±0.1	-	±1.0	-	±1.0	µA
I_{OZ}	OFF-state output current	QPn output is HIGH; V_O = 15 V	5 V	-	2	-	2	-	15	-	15	µA
			10 V	-	2	-	2	-	15	-	15	µA
			15 V	-	2	-	2	-	15	-	15	µA
I_{DD}	supply current	I_O = 0 A	5 V	-	5	-	5	-	150	-	150	µA
			10 V	-	10	-	10	-	300	-	300	µA
			15 V	-	20	-	20	-	600	-	600	µA
C_I	input capacitance		-	-	-	-	-	7.5	-	-	-	pF

10. Dynamic characteristics

Table 7. Dynamic characteristics

V_{SS} = 0 V; T_{amb} = 25 °C unless otherwise specified. For test circuit, see Fig. 9.

Symbol	Parameter	Conditions	V_{DD}	Extrapolation formula[1]	Min	Typ	Max	Unit
t_{PHL}	HIGH to LOW propagation delay	CP to QS1; see Fig. 5	5 V	132 ns + (0.55 ns/pF)C_L	-	160	320	ns
			10 V	53 ns + (0.23 ns/pF)C_L	-	65	130	ns
			15 V	37 ns + (0.16 ns/pF)C_L	-	45	90	ns
		CP to QS2; see Fig. 5	5 V	92 ns + (0.55 ns/pF)C_L	-	120	240	ns
			10 V	39 ns + (0.23 ns/pF)C_L	-	50	100	ns
			15 V	32 ns + (0.16 ns/pF)C_L	-	40	80	ns
t_{PLH}	LOW to HIGH propagation delay	CP to QS1; see Fig. 5	5 V	102 ns + (0.55 ns/pF)C_L	-	130	260	ns
			10 V	44 ns + (0.23 ns/pF)C_L	-	55	110	ns
			15 V	32 ns + (0.16 ns/pF)C_L	-	40	80	ns
		CP to QS2; see Fig. 5	5 V	102 ns + (0.55 ns/pF)C_L	-	130	260	ns
			10 V	49 ns + (0.23 ns/pF)C_L	-	60	120	ns
			15 V	37 ns + (0.16 ns/pF)C_L	-	45	90	ns
t_{PZL}	OFF-state to LOW propagation delay	CP to QPn; see Fig. 5	5 V		-	240	480	ns
			10 V		-	80	160	ns
			15 V		-	55	110	ns
		STR to QPn; see Fig. 6	5 V		-	140	280	ns
			10 V		-	70	140	ns
			15 V		-	55	110	ns
t_{PLZ}	LOW to OFF-state propagation delay	CP to QPn; see Fig. 5	5 V		-	170	340	ns
			10 V		-	75	150	ns
			15 V		-	60	120	ns
		STR to QPn; see Fig. 6	5 V		-	100	200	ns
			10 V		-	40	100	ns
			15 V		-	35	70	ns
t_{en}	enable time	OE to QPn; see Fig. 7	5 V [2]		-	100	200	ns
			10 V		-	55	110	ns
			15 V		-	50	100	ns
t_{dis}	disable time	OE to QPn; see Fig. 7	5 V [2]		-	80	160	ns
			10 V		-	40	80	ns
			15 V		-	30	60	ns
t_t	transition time	QS1, QS2; see Fig. 5	5 V [3]	35 ns + (1.00 ns/pF)C_L	-	85	170	ns
			10 V	19 ns + (0.42 ns/pF)C_L	-	40	80	ns
			15 V	16 ns + (0.28 ns/pF)C_L	-	30	60	ns
t_W	pulse width	CP LOW and HIGH; see Fig. 5	5 V		60	30	-	ns
			10 V		30	15	-	ns
			15 V		24	12	-	ns
		STR HIGH; see Fig. 6	5 V		80	40	-	ns
			10 V		60	30	-	ns
			15 V		24	12	-	ns

Symbol	Parameter	Conditions	V_{DD}	Extrapolation formula[1]	Min	Typ	Max	Unit
t_{su}	set-up time	D to CP; see Fig. 8	5 V		60	30	-	ns
			10 V		20	10	-	ns
			15 V		15	5	-	ns
t_h	hold time	D to CP; see Fig. 8	5 V		+5	-15	-	ns
			10 V		20	5	-	ns
			15 V		20	5	-	ns
$f_{clk(max)}$	maximum clock frequency	CP; see Fig. 5	5 V		5	10	-	MHz
			10 V		11	22	-	MHz
			15 V		14	28	-	MHz

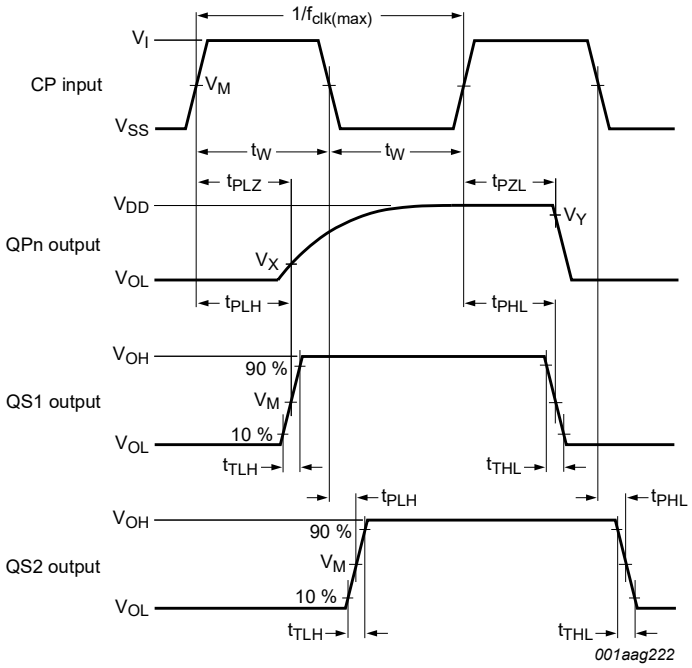
[1] The typical values of the propagation delay and transition times are calculated from the extrapolation formulas shown (C_L in pF).
[2] t_{en} is the same as t_{PZL} and t_{dis} is the same as t_{PLZ}
[3] t_t is the same as t_{TLH} and t_{THL}

Table 8. Dynamic power dissipation

P_D can be calculated from the formulas shown. V_{SS} = 0 V; $t_r = t_f \leq 20$ ns; T_{amb} = 25 °C.

Symbol	Parameter	V_{DD}	Typical formula	Where
P_D	dynamic power dissipation	5 V	$P_D = 1200 \times f_i + \Sigma(f_o \times C_L) \times V_{DD}^2$ µW	f_i = input frequency in MHz; f_o = output frequency in MHz; C_L = output load capacitance in pF; $\Sigma(f_o \times C_L)$ = sum of the outputs; V_{DD} = supply voltage in V.
		10 V	$P_D = 5550 \times f_i + \Sigma(f_o \times C_L) \times V_{DD}^2$ µW	
		15 V	$P_D = 15000 \times f_i + \Sigma(f_o \times C_L) \times V_{DD}^2$ µW	

10.1. Waveforms and test circuit



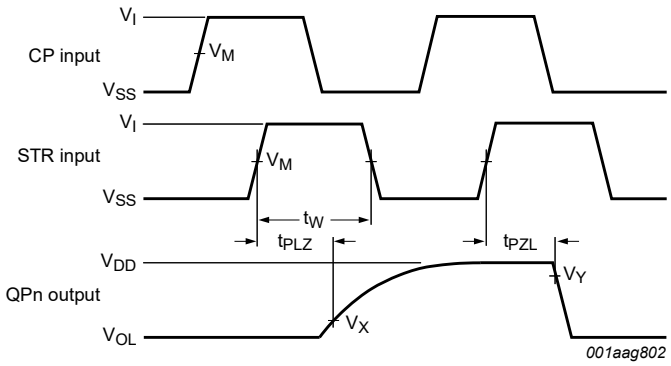
Parallel output measurement points are given in Table 9.

V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig. 5. Propagation delay clock (CP) to output (QPn, QS1, QS2), clock pulse width and maximum clock frequency

Table 9. Measurement points

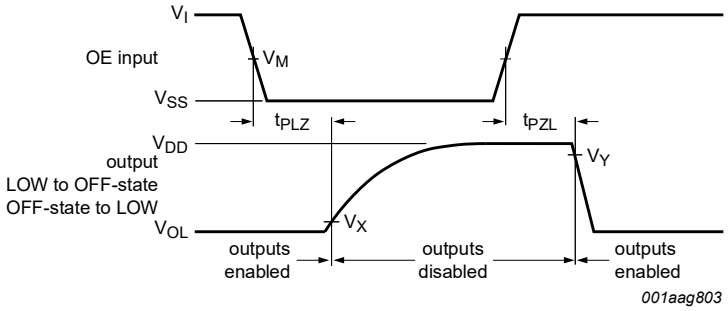
Supply	Input	Output		
V_{DD}	V_M	V_M	V_X	V_Y
5 V to 15 V	0.5 × V_{DD}	0.5 × V_{DD}	0.1 × V_O	0.9 × V_O



Measurement points are given in Table 9.

V_{OL} is the typical output voltage level that occurs with the output load.

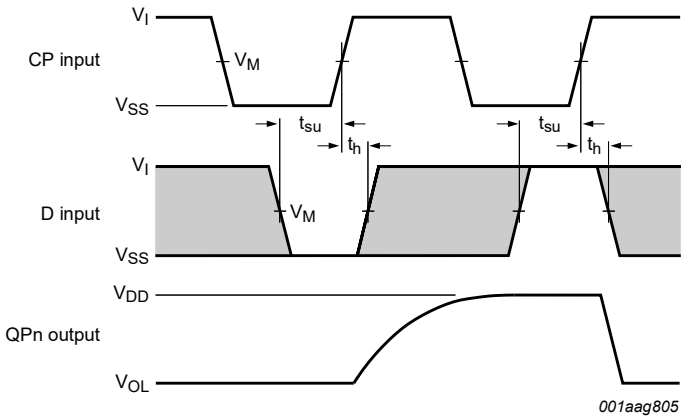
Fig. 6. Strobe (STR) to output (QPn) propagation delays and the strobe pulse width



Measurement points are given in Table 9.

V_{OL} is the typical output voltage level that occurs with the output load.

Fig. 7. Enable and disable times for input OE

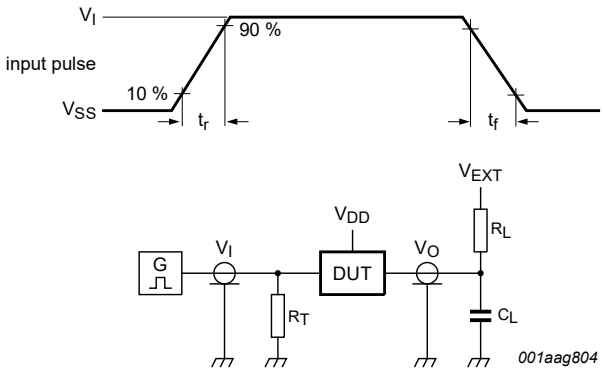


Measurement points are given in Table 9.

The shaded areas indicate when the input is permitted to change for predictable output performance.

V_{OL} is the typical output voltage level that occurs with the output load.

Fig. 8. Set-up and hold times for the data input (D)



Test data is given in Table 10.

Definitions for test circuit:

R_L = Load resistance;

C_L = load capacitance;

R_T = Termination resistance should be equal to output impedance of Z_o of the pulse generator;

V_{EXT} = External voltage for measuring switching times.

Fig. 9. Test circuit for measuring switching times

Table 10. Test data

Supply	Input		V_{EXT}		Load	
V_{DD}	V_I	t_r, t_f	t_{PLZ}, t_{PZL}	t_{PLH}, t_{PHL}	C_L	R_L
5 V to 15 V	V_{DD}	≤ 20 ns	V_{DD}	open	50 pF	1 kΩ

11. Application information

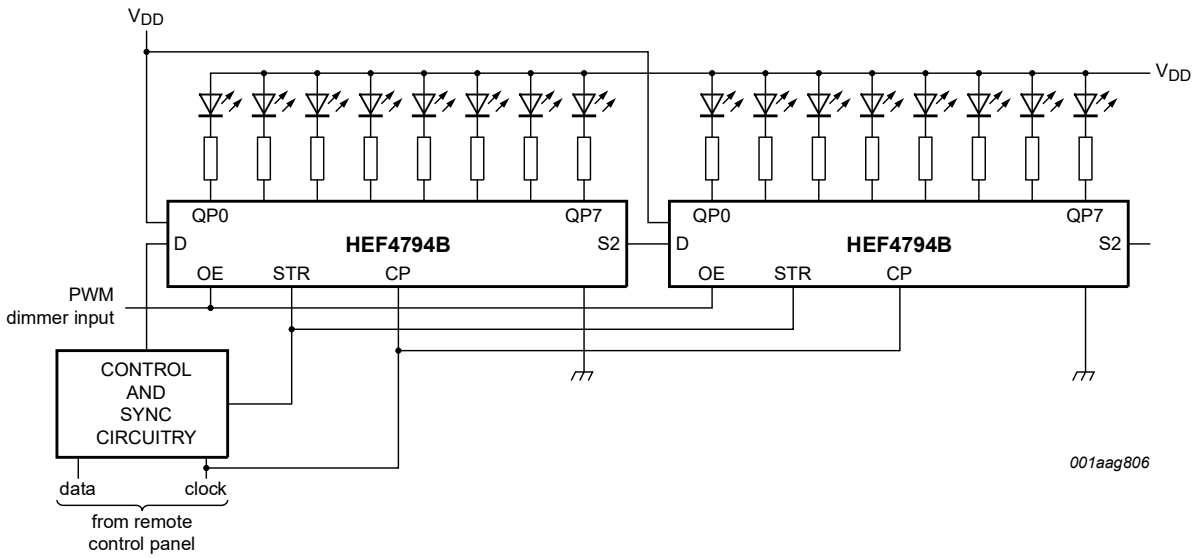
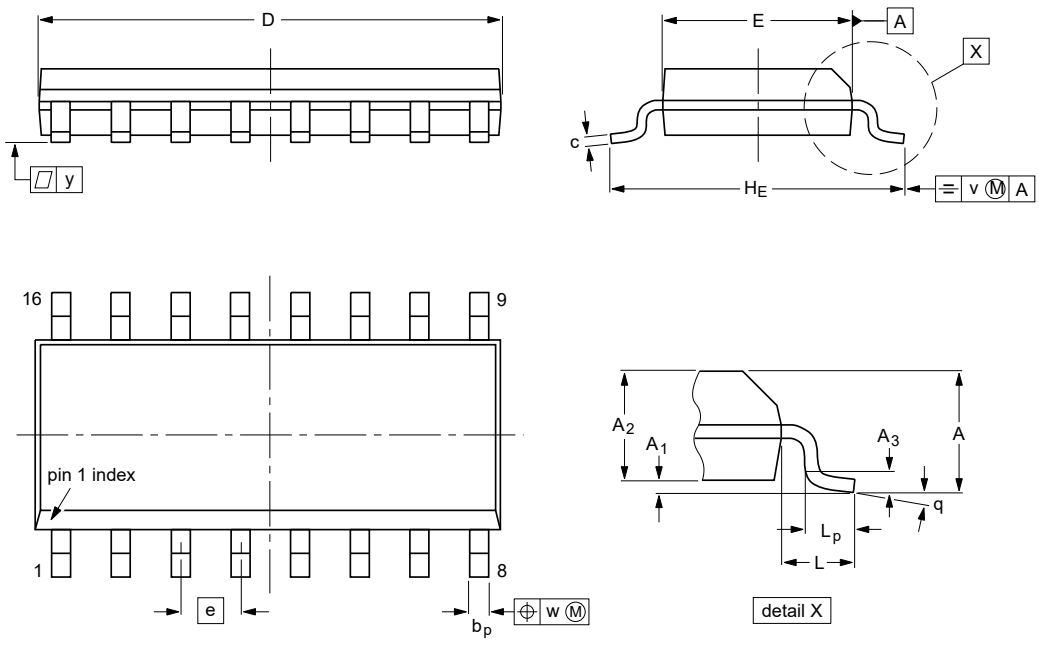


Fig. 10. Application example: serial-to-parallel data converting LED drivers

12. Package outline

SO16: plastic small outline package; 16 leads; body width 3.9 mm **SOT109-1**



Dimensions (inch dimensions are derived from the original mm dimensions)

Unit		A	A_1	A_2	A_3	b_p	c	$D^{(1)}$	$E^{(1)}$	e	H_E	L	L_p	v	w	y	θ
mm	max	1.75	0.25			0.51	0.25	10.0	4.0		6.2		1.27				8°
	nom				0.25					1.27		1.05		0.2	0.25	0.1	
	min		0.10	1.25		0.31	0.10	9.8	3.8		5.8		0.4				0°
inches	max	0.069	0.010			0.020	0.010	0.394	0.16		0.244		0.05				8°
	nom				0.01					0.05		0.041		0.008	0.01	0.004	
	min		0.004	0.049		0.012	0.004	0.386	0.15		0.228		0.016				0°

Note
1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

sot109-1_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOT109-1		MS-012				~~03-02-19~~ 23-10-27

Fig. 11. Package outline SOT109-1 (SO16)

13. Abbreviations

Table 11. Abbreviations

Acronym	Description
ANSI	American National Standards Institute
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
ESDA	ElectroStatic Discharge Association
HBM	Human Body Model
JEDEC	Joint Electron Device Engineering Council

14. Revision history

Table 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
HEF4794B v.11	20240814	Product data sheet	-	HEF4794B v.10
Modifications:	• Section 2: ESD specification updated according to the latest JEDEC standard. • Fig. 11: Aligned SO package outline drawing to JEDEC MS-012			
HEF4794B v.10	20220106	Product data sheet	-	HEF4794B v.9
Modifications:	• Section 2 updated and Section 13 added.			
HEF4794B v.9	20181107	Product data sheet	-	HEF4794B v.8
Modifications:	• The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia. • Legal texts have been adapted to the new company name where appropriate. • Fig. 3 and Fig. 4 corrected.			
HEF4794B v.8	20160404	Product data sheet	-	HEF4794B v.7
Modifications:	• Type number HEF4794BP (SOT38-4) removed.			
HEF4794B v.7	20111116	Product data sheet	-	HEF4794B v.6
Modifications:	• Section Applications removed • Table 6: I_{OH} minimum values changed to maximum added the unit pF for C_I			
HEF4794B v.6	20100901	Product data sheet	-	HEF4794B v.5
HEF4794B v.5	20100402	Product data sheet	-	HEF4794B v.4
HEF4794B v.4	20091222	Product data sheet	-	HEF4794B v.3
HEF4794B v.3	20080812	Product data sheet	-	HEF4794B v.2
HEF4794B v.2	19990630	Product specification	-	HEF4794B v.1
HEF4794B v.1	19940701	Product specification	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.
[2] The term 'short data sheet' is explained in section "Definitions".
[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at https://www.nexperia.com.

Definitions

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